



DMP3036SFV

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C		
001/	20mΩ @ V _{GS} = -10V	004		
-30V	29mΩ @ V _{GS} = -5V	-30A		

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load Switch
- Power Management Functions

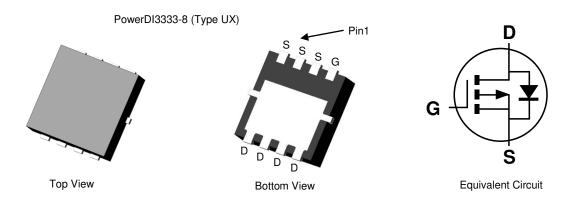
30V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8 (Type UX)

Features

- Low R_{DS(ON)} – Ensures On State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher **Density End Products**
- Occupies Just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI[®]3333-8 (Type UX)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.03 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3036SFV-7	PowerDI3333-8 (Type UX)	2000/Tape & Reel
DMP3036SFV-13	PowerDI3333-8 (Type UX)	3000/Tape & Reel

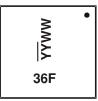
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

Notes:

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



<u>36F</u> = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

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1 of 7 www.diodes.com



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	-30	V	
Gate-Source Voltage	V _{GSS}	±25	V	
Continuous Drain Current, V _{GS} = -10V (Note 6)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-8.7 -7.0	А
Continuous Drain Current, V_{GS} = -10V (Note 7)	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	Ι _D	-30 -25	А
Maximum Continuous Body Diode Forward Current (Note 7)	ls	-3.6	А	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	IDM	-80	А	
Avalanche Current, L = 0.3mH (Note 8)	IAS	-17.5	А	
Avalanche Energy, L = 0.3mH (Note 8)		E _{AS}	64	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	137	°C/W
Total Power Dissipation (Note 6)		PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	55	°C/W
Thermal Resistance, Junction to Case (Note 7)		$R_{\theta JC}$	3.5	-C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)					1		
Drain-Source Breakdown Voltage	BV _{DSS}	-30	—	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	_	-2.5	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance		-	_	20	mΩ	$V_{GS} = -10V, I_D = -8A$	
	R _{DS(ON)}	_	_	29	11152	$V_{GS} = -5V, I_D = -5A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		1931	_		$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz	
Output Capacitance	Coss		226	_	pF		
Reverse Transfer Capacitance	Crss	-	168	_			
Gate Resistance	R _G	_	11	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -5V)	Qg	_	8.8	_			
Total Gate Charge (V _{GS} = -10V)	Qq	_	16.5		nC	$V_{DS} = -15V, I_D = -10A$	
Gate-Source Charge	Q _{gs}	_	2.6	_	no		
Gate-Drain Charge	Q _{gd}	_	3.6	_			
Turn-On Delay Time	t _{D(ON)}	_	8.2	_			
Turn-On Rise Time	t _R	_	14			$\label{eq:VDD} \begin{array}{l} V_{DD} = -15V, V_{GS} = -10V, \\ R_{GEN} = 3\Omega, I_D = -10A \end{array}$	
Turn-Off Delay Time	t _{D(OFF)}		65		ns		
Turn-Off Fall Time	tF		31.6		1		
Reverse Recovery Time	t _{RR}		9.3	_	ns		
Reverse Recovery Charge	Q _{RR}		12.2	_	nC	I _F = -8A, di/dt = 500A/μs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

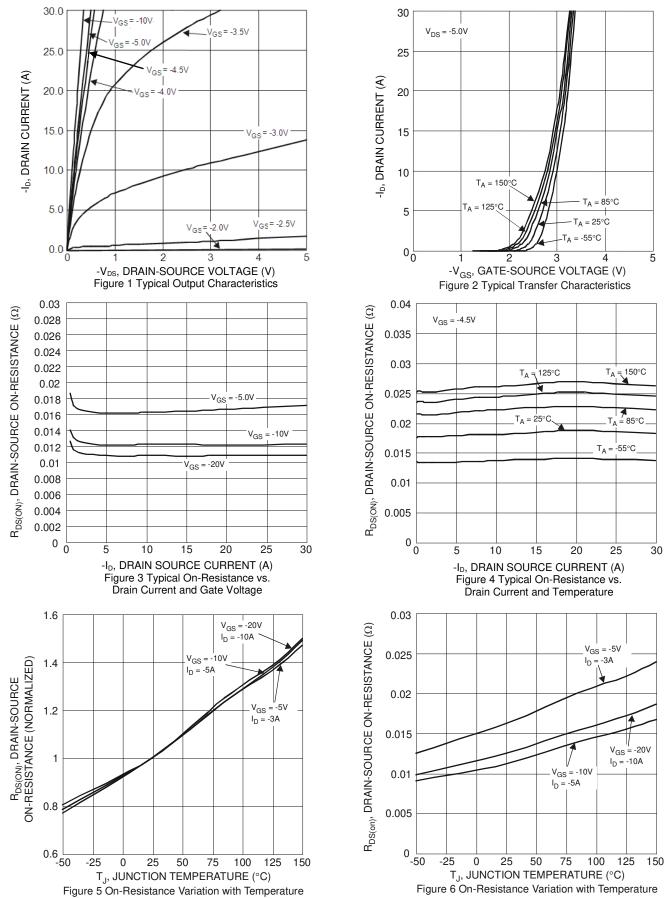
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).

8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.

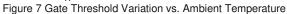


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2.5 -V_{GS(TH)}, GATE THRESHOLD VOLTAGE (V) 2.3 2.1 1.9 =1mA 1.7 = 250µÅ -I_D 1.5 1.3 1.1 0.9 0.7 0.5 -50 -25 0 25 50 75 100 125 150 T_A, AMBIENT TEMPERATURE (°C)



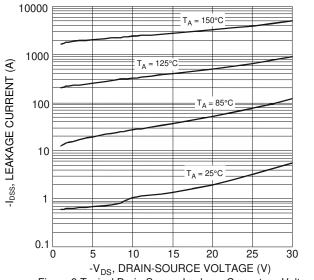
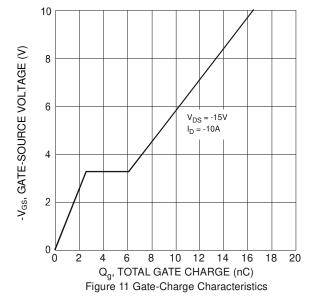
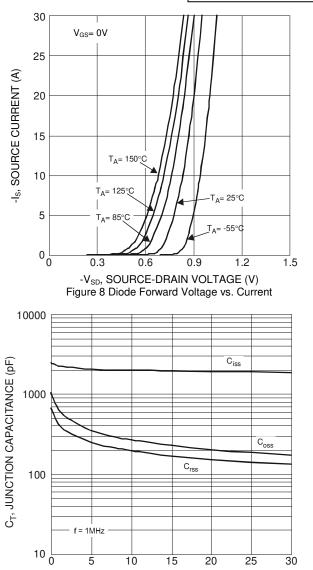
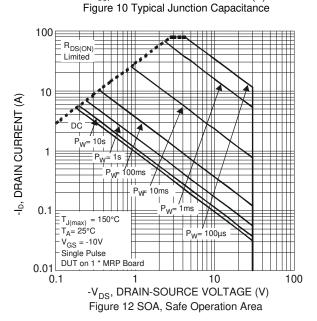


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

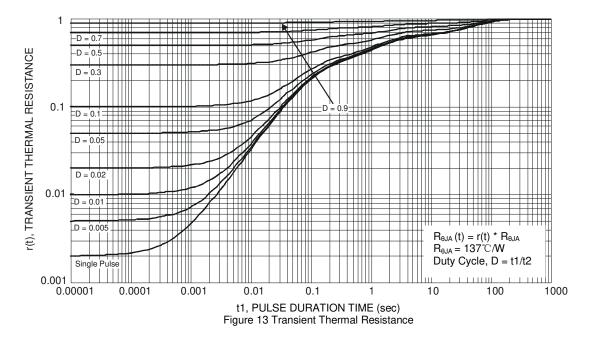






-V_{DS}, DRAIN-SOURCE VOLTAGE (V)



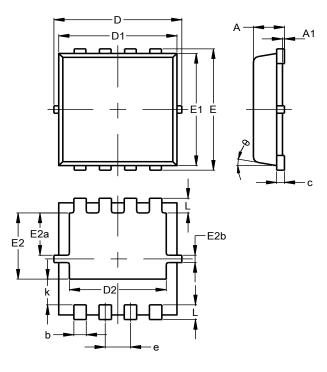




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)

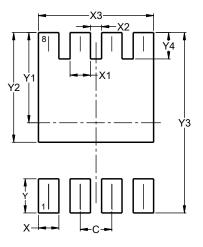


	PowerDI3333-8 (Type UX)					
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05				
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	2.30	2.70	2.50			
E	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E2a	0.95	1.35	1.15			
E2b	0.10	0.30	0.20			
е	0.65 BSC					
k	0.50	0.90	0.70			
L	0.30	0.50	0.40			
θ	0°	12°	10°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
X3	2.370		
Y	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Y4	0.540		



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